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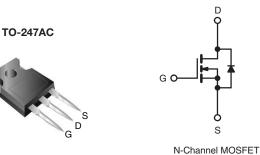




Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	600			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.24		
Q _g (Max.) (nC)	150			
Q _{gs} (nC)	45			
Q _{gd} (nC)	76			
Configuration	Single			



FEATURES

• Low Gate Charge Q_q Results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS COMPLIANT Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Enhanced Body Diode dV/dt Capability
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

- Hard Switching Primary or PFS Switch
- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- Motor Drive

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP22N60KPbF
	SiHFP22N60K-E3
SnPb	IRFP22N60K
	SiHFP22N60K

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted)							
PARAMETER	SYMBOL	LIMIT	UNIT				
Drain-Source Voltage		V _{DS}	600	v			
Gate-Source Voltage	V _{GS}	± 30	V				
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 \text{ °C}$	I _D	22				
	V_{GS} at 10 V $T_C = 100 ^{\circ}C$		14	А			
Pulsed Drain Current ^a	I _{DM}	88					
Linear Derating Factor		2.9	W/°C				
Single Pulse Avalanche Energy ^b		E _{AS}	380	mJ			
Repetitive Avalanche Current ^a	I _{AR} 22		A				
Repetitive Avalanche Energy ^a	E _{AR}	37	mJ				
Maximum Power Dissipation	T _C = 25 °C	PD	P _D 370				
Peak Diode Recovery dV/dt ^c		dV/dt	15	V/ns			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C			
Soldering Recommendations (Peak Temperature)	for 10 s 3		300 ^d				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25$ °C, L = 1.5 mH, $R_g = 25 \Omega$, $I_{AS} = 22$ A (see fig. 12).

c. $I_{SD} \leq 22$ A, dI/dt ≤ 360 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 150 \ ^{\circ}C.$

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum Junction-to-Ambient						UNIT		
Case-to-Sink, Flat, Greased Surface	R _{thJA} R _{thCS}	- 40				°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.34						
	- 4150							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	1		ONS	MIN.	TYP.	MAX.	UNI
Static						1	1	<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = 250 µA		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}^d$		-	0.30	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}		$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3.0	-	5.0	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30 V$		-	-	± 100	nA	
		$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	50		
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		= 13 A ^b	-	0.240	0.280	Ω
Forward Transconductance		V _{DS} =	= 50 V, I _D = 1	3 A ^b	11	-	-	S
Dynamic						1	1	L
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V,			-	3570	-	
Output Capacitance	C _{oss}			-	350	-	1	
Reverse Transfer Capacitance	C _{rss}	f = 1	f = 1.0 MHz, see fig. 5		-	36	-	1
			V _{DS} = 1.0 \	/ , f = 1.0 MHz	-	4710	-	pF
Output Capacitance	Coss	$V_{GS} = 0 V$	$V_{DS} = 480$	V , f = 1.0 MHz	-	92	-	
Effective Output Capacitance	Coss eff.		$V_{DS} = 0$	V to 480 V	- 180		-	1
Total Gate Charge	Qg				-	-	150	
Gate-Source Charge	Q _{gs}			A, $V_{DS} = 480 V$	-	-	45	nC
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13		-	-	76	
Turn-On Delay Time	t _{d(on)}				-	26	-	1
Rise Time	t _r		V _{DD} = 300 V, I _D = 22 A,		-	99	-	1
Turn-Off Delay Time	t _{d(off)}	R _g = 6.2, V _{GS} = 10 V, see fig. 10 ^b		-	48	-	ns	
Fall Time	t _f			-	37	-		
Drain-Source Body Diode Characteristic	s							I
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the			-	-	22	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	88	A	
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, I _S = 22 A, ∖	/ _{GS} = 0 V ^b	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C			-	590	890	ns
		T _J = 125 °C			-	670	1010	
Body Diode Reverse Recovery Charge	Q _{rr}	-			-	7.2	11	μC
		T _J =1 25 °C			_	8.5	13	
Reverse Recovery Current	I _{RRM}	., .200	T _{.1} = 25 °C		-	26	39	<u> </u>
Forward Turn-On Time	t _{on}	Intrincia to	•	s negligible (turn-	op is de			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

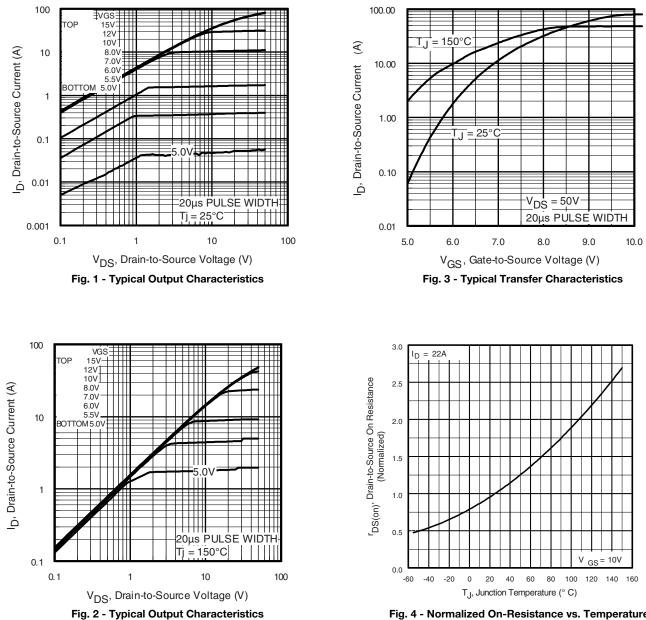
b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 4 - Normalized On-Resistance vs. Temperature

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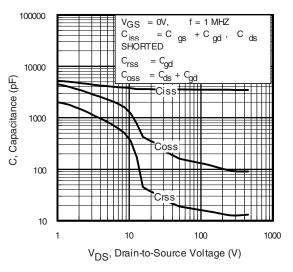


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

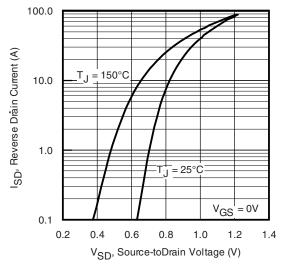


Fig. 7 - Typical Source-Drain Diode Forward Voltage

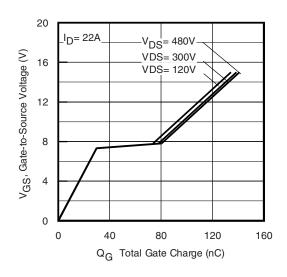


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

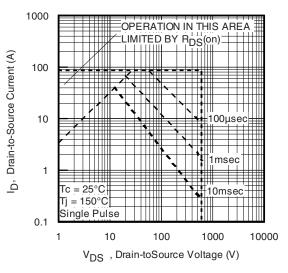


Fig. 8 - Maximum Safe Operating Area



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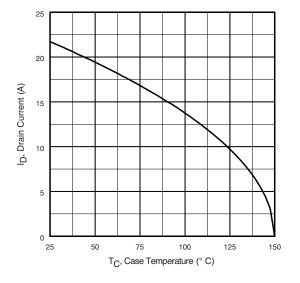


Fig. 9 - Maximum Drain Current vs. Case Temperature

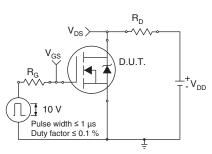


Fig. 10a - Switching Time Test Circuit

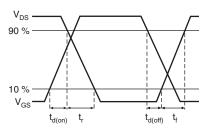


Fig. 10b - Switching Time Waveforms

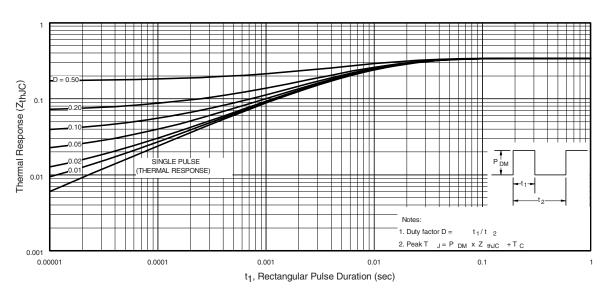


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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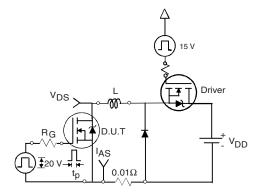


Fig. 12a - Unclamped Inductive Test Circuit

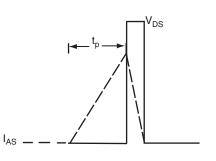


Fig. 12b - Unclamped Inductive Waveforms

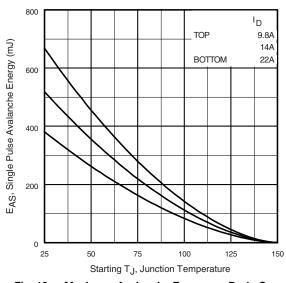
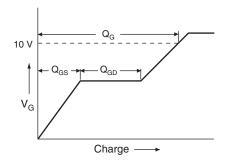


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





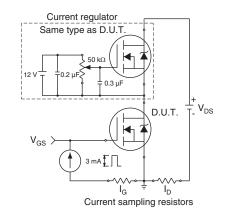
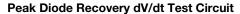


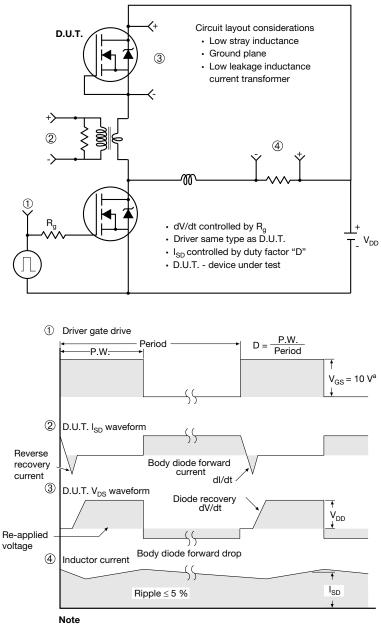
Fig. 13b - Gate Charge Test Circuit

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a. V_{GS} = 5 V for logic level devices

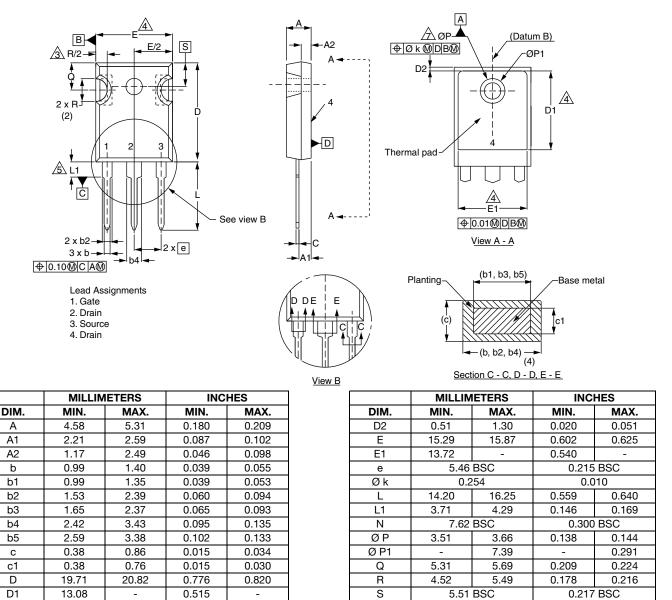
Fig. 14 - For N-Channel

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TO-247AC (High Voltage)

ECN: X13-0103-Rev. D, 01-Jul-13 DWG: 5971

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Contour of slot optional.

 Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.

4. Thermal pad contour optional with dimensions D1 and E1.

5. Lead finish uncontrolled in L1.

6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").

7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.

8. Xian and Mingxin actually photo.



Document Number: 91360



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